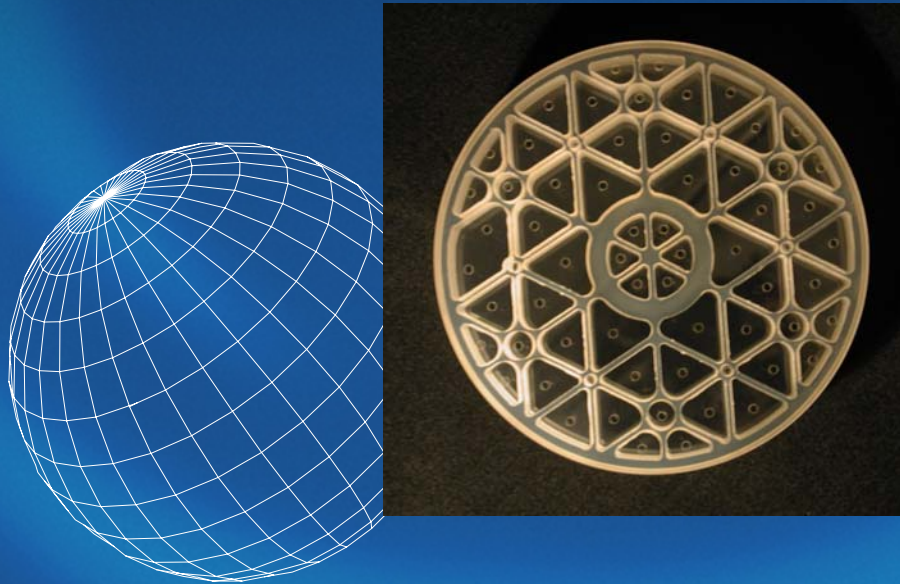


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SCHOTT Low Temperature Bonding for Precision Optics

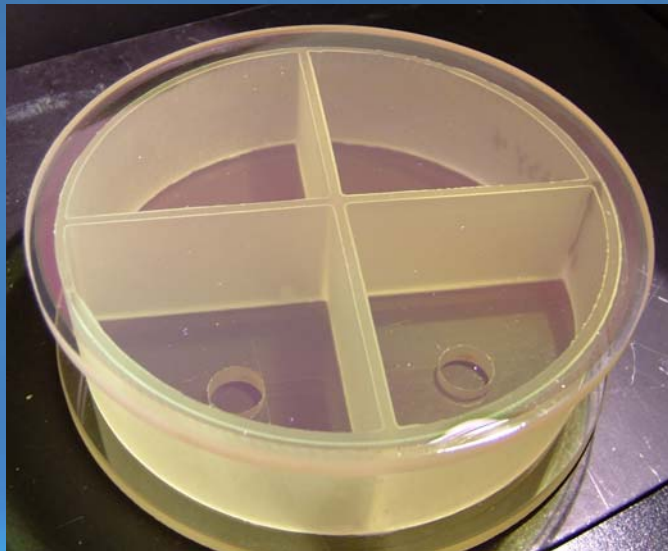


Carol Click, Leo Gilroy and Dave Vanderpool
SCHOTT North America

Outline of topics to be covered

- Overview of Low Temperature Bonding
 - Process overview
 - Materials that can be bonded
- Measured properties of LTB components
 - Bond thickness
 - Mechanical strength
 - Total change in length
 - Stability
 - Stress birefringence
- Summary and future work

Overview of LTB



What is LTB?

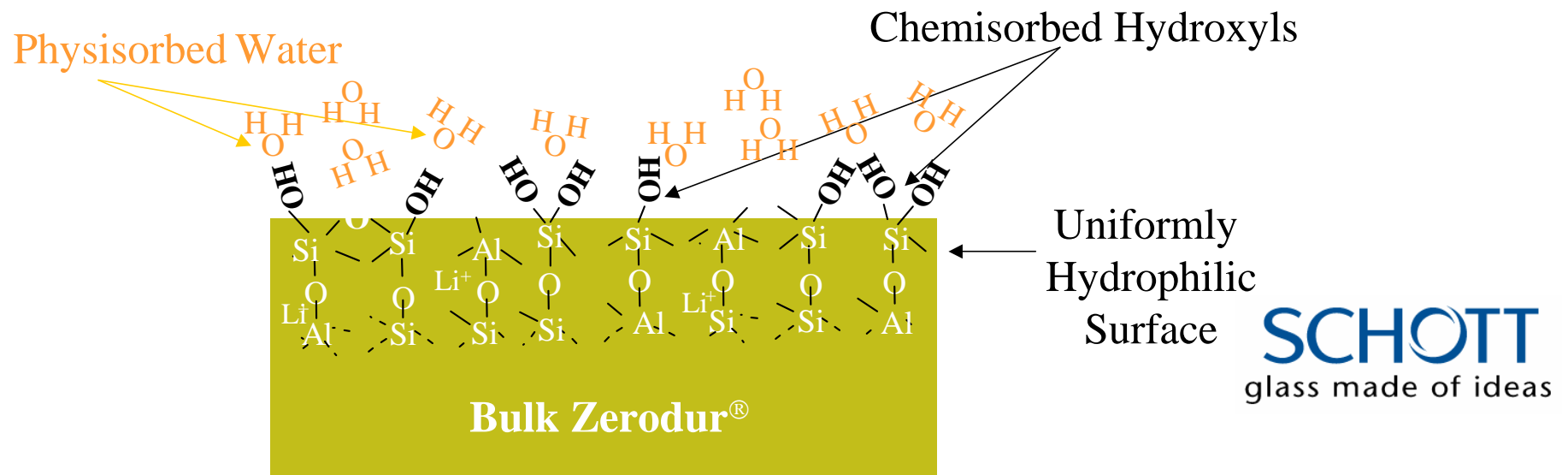
- Low temperature (<120°C)
 - Fabrication is done at room temperature and cured at 120°C
- Aqueous and inorganic
 - No organic out-gassing issues
- Permanent
 - High aqueous durability and is stable from 30K to 1000K
- Optically transparent
 - More transparent than the Zerodur®
- Mechanically robust
 - Bonded components have strengths similar to monolithic components
- Vacuum compatible
 - Bonded components are ultra-high vacuum compatible and survive coating chambers
- Post-bond process-able
 - Bonded components can be polished after curing without degradation of the bond

SCHOTT Proprietary LTB Process

- Components are prepared for bonding
 - Grinding and polishing of faces that will be bonded
 - Aqueous based cleaning to remove surface contamination and activate the surface to a hydrophilic state
- Solution is applied to bonding faces and the components are brought into contact
- Alignment of the component is performed in the first 2 minutes
- Components are allowed to sit undisturbed for 6-12 hours
- Component is cured for ~1 week – depending on sample geometry
- Component is now ready for post-processing
 - Polishing
 - Coating
- Small voids are cosmetic and do not appear to affect overall quality of the bond

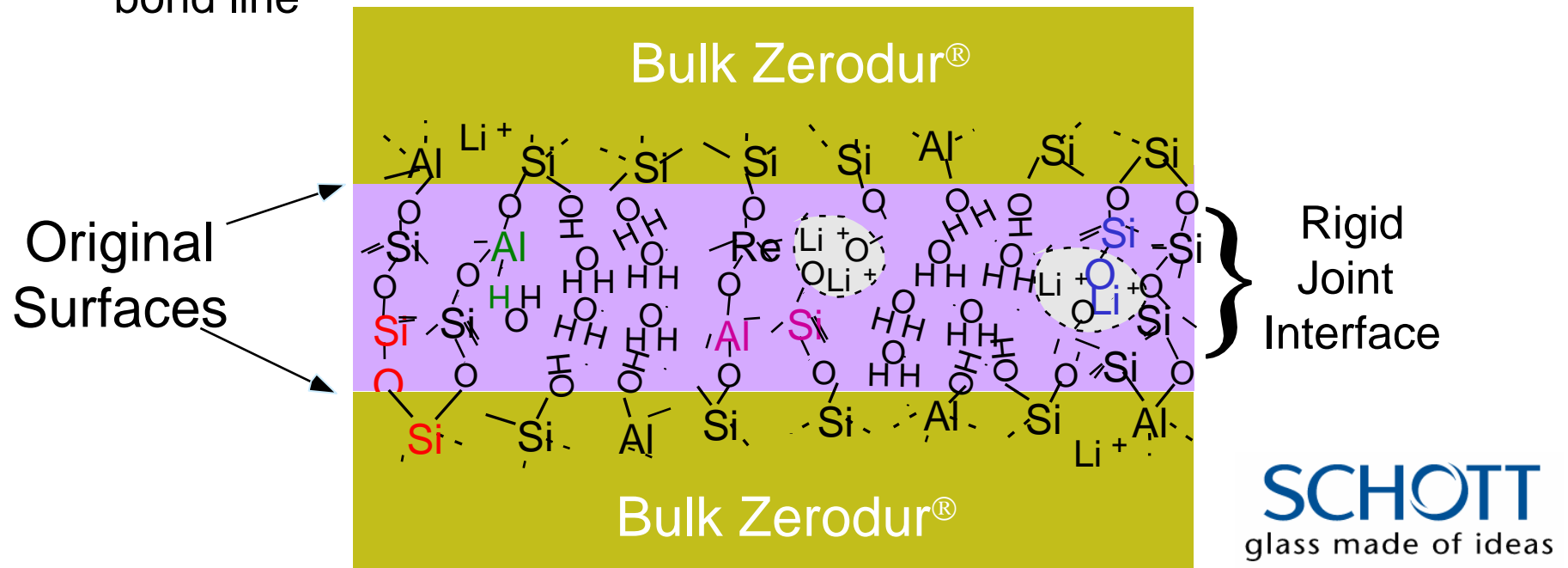
Surface activation for LTB

- Surface must be hydrophilic for uniform wetting of the surface and resulting uniform bonds
 - Hydrophilic vs. hydrophobic is measured by the contact angle
 - Small contact angles indicate a hydrophilic surface which is desirable for bonding (typically $<30^\circ$)
- Hydrophilic surfaces have both chemically absorbed hydroxyl ions and physically absorbed water molecules
 - The more uniform the coverage of the water molecules and hydroxyl ions, the better the overall bond quality



Reactive bonding is initiated by the inorganic bonding solution being applied to the joint

- Multiple bonding mechanisms are present:
 - Hydrogen bonding
 - Alkali ion to non-bridging oxygen bonding
 - Si – O – Si network bonding
- Joint cures rigid while dehydration of the joint occurs through the bond line



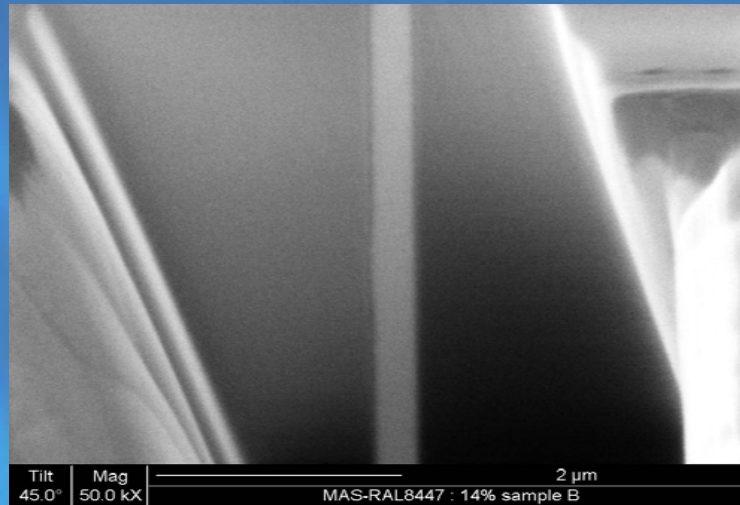
Post-processing

- After bonding, the components are cured
 - From room temperature to 120°C
- After curing, the components can be thermal cycled (77K to 200°C) to remove residual stress
- After curing and thermal cycling the joints are stable and are capable of being polished and coated into a final component

LTB compatible materials

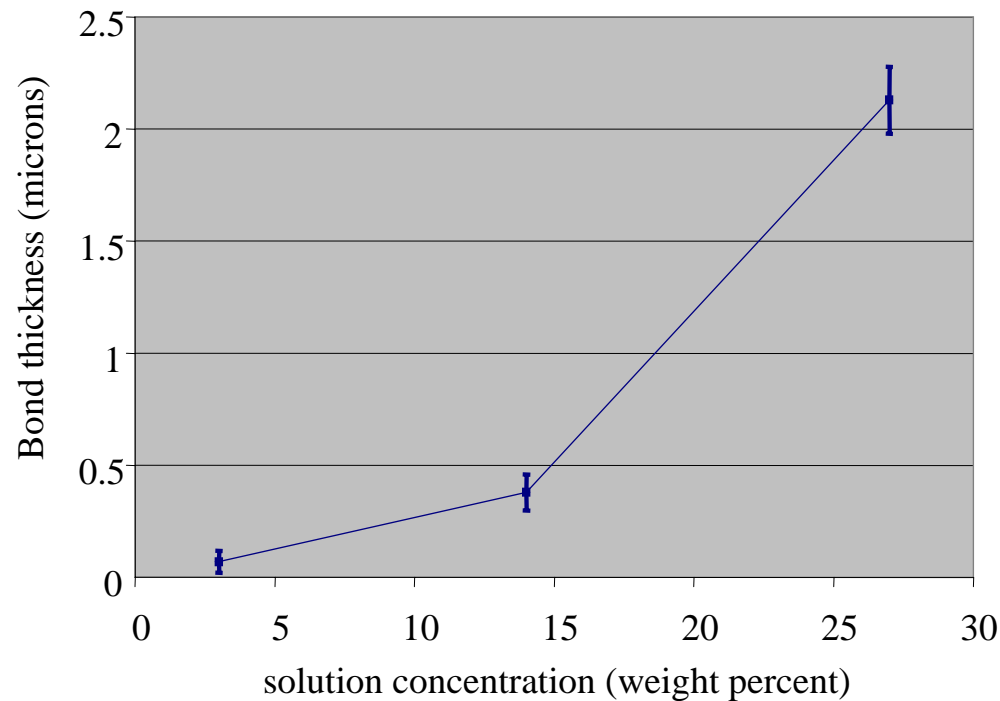
- **Glasses** – Silicates, phosphates, multi-component glasses, heavy metal oxides
- **Glass ceramics** – **Zerodur®** and Ceran®
- **Crystalline materials** – Sapphire, silicon, GaAs, Nd-YAG, Indium Tin Oxide, LiNbO_3 , CaF_2 , MgF_2
- **Metals** – Invar, copper/tungsten, aluminum, copper

Measured properties of LTB bonded components



Bond thickness is dependent upon solution chemistry

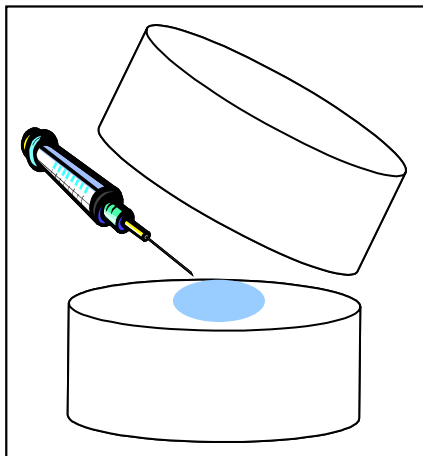
- The bond thickness has been measured using a Focused Ion Beam on a Scanning Electron Microscope (FIB/SEM)
- The bond thickness can be varied between 100nm and 2.2 μ m on $\lambda/3$ flat Zerodur[®] surfaces



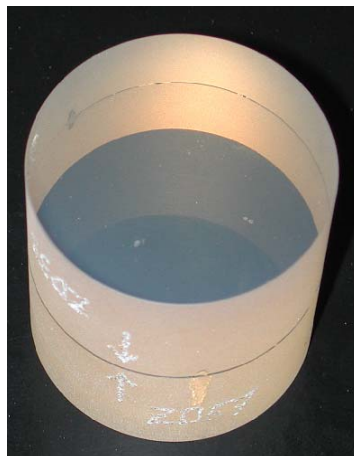
Strength testing of bonded Zerodur® assemblies

- A silicate-based LTB solution was prepared and 2" diameter, 2" tall samples, with either polished or fine ground surfaces, were bonded together ("hockey-pucks")
- Bonded samples were either cured at room temperature or at a maximum temperature of 110 °C (Standard Cure)
- Rods were core-drilled and 4-pt flexure testing was done in accordance with ASTM 1161-02C using circular cross sections
- Core drilling impart stress and flaws to the surface, so this data gives us a rough order of measure on strength values!

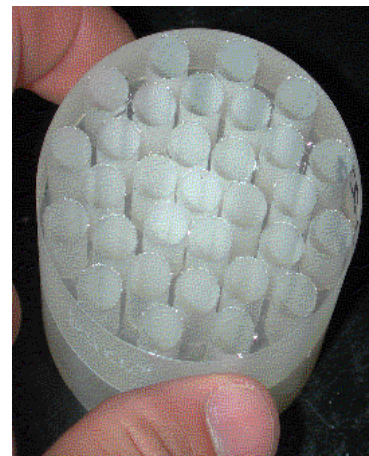
1. Bond



2. Cure



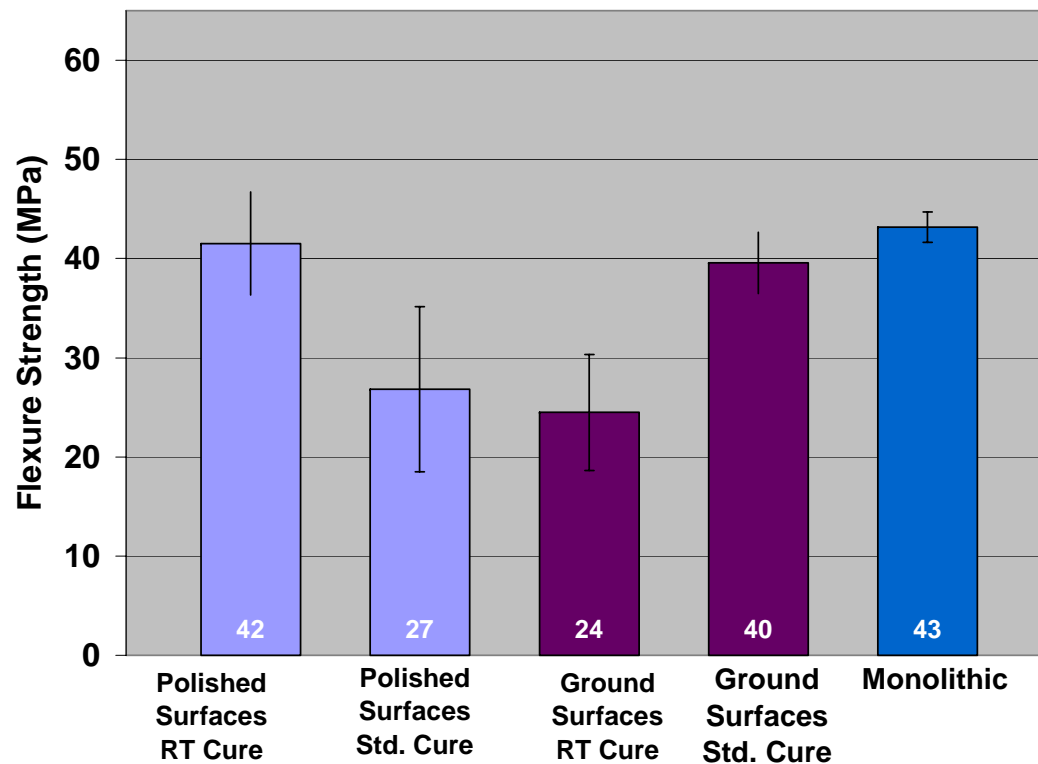
3. Core Drill



4. Test Strength

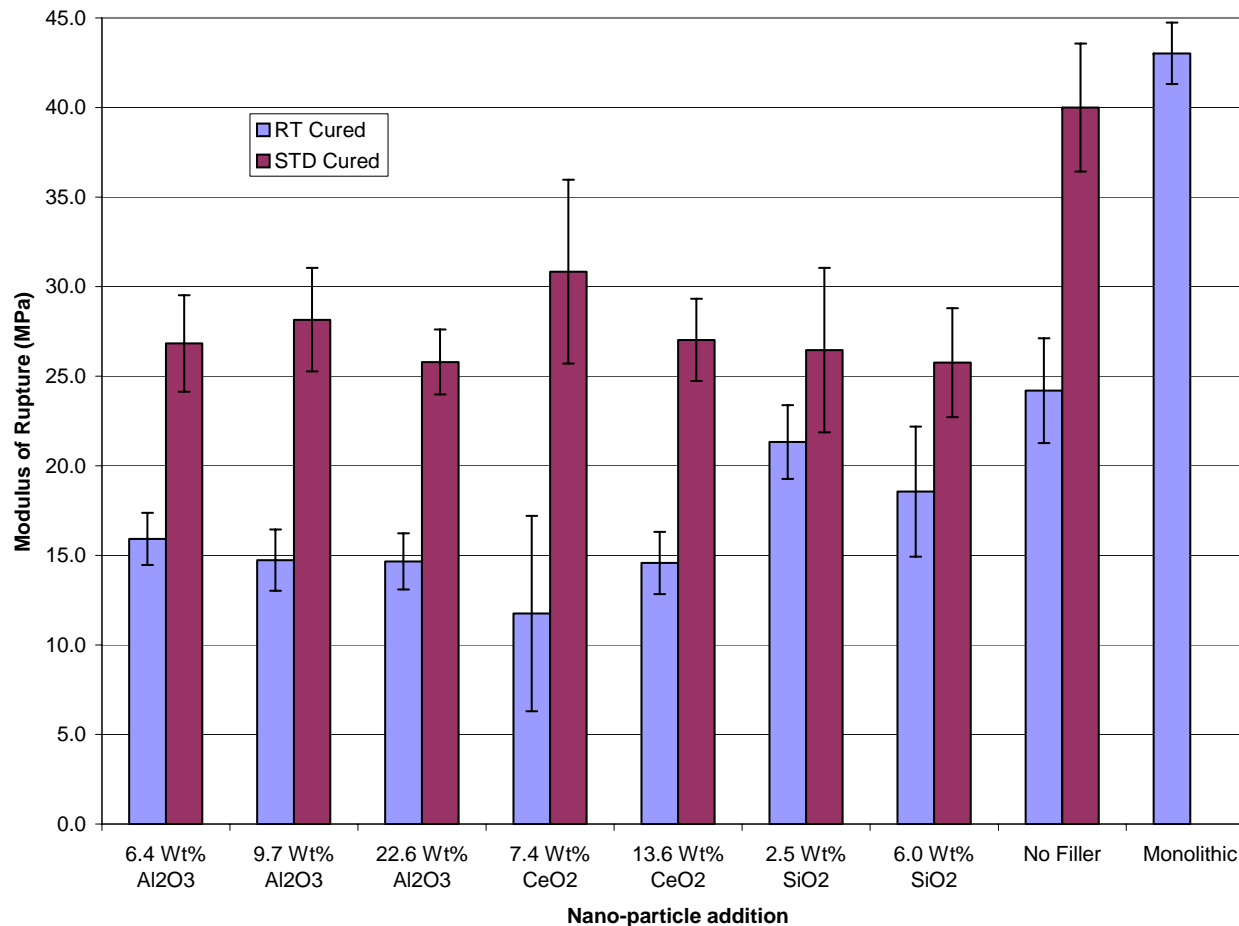


Bonded components can be produced with similar strengths to monolithic Zerodur®



- Assemblies made using polished surfaces ($\lambda/3$) are stronger with a room temperature cure as opposed to a high temperature treatment
- Assemblies made with ground surfaces should be heat treated to provide strength values that approach that of the monolithic

Nano-particles were added to increase the strength of fine ground bonded Zerodur®



- Nano-particle additions did not increase the strength of the bonded components, which would have indicated successful gap filling

MOR of core drilled Zerodur® can be altered via surface treatment

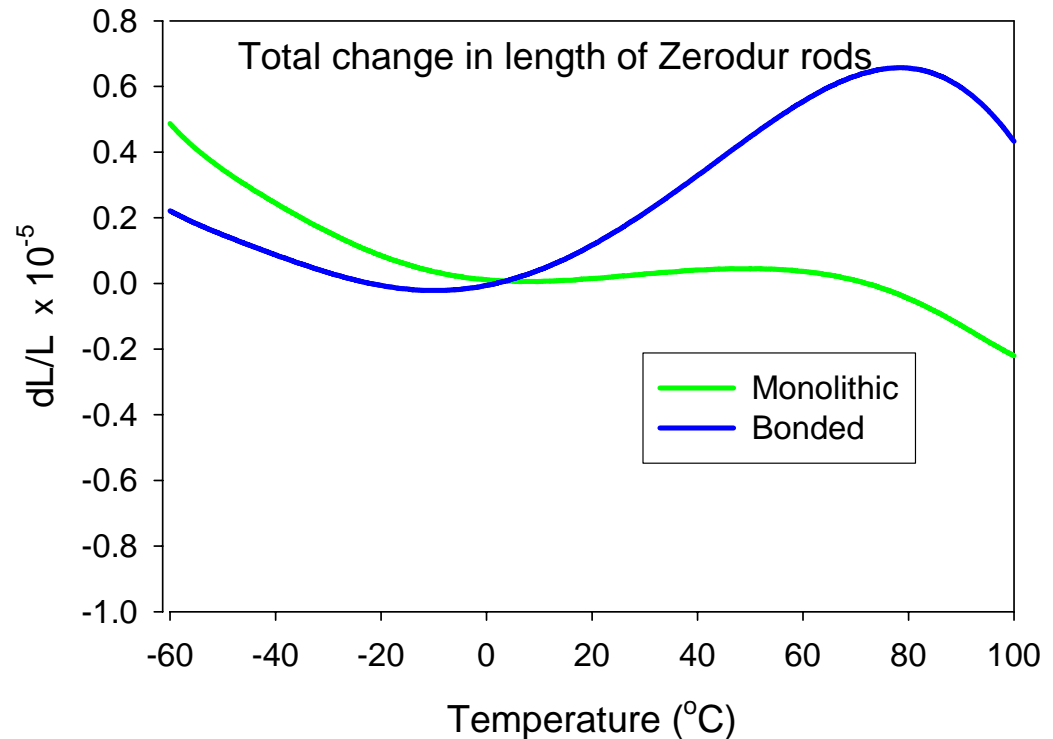
- Monolithic Zerodur® was core drilled into 5mm diameter rods (70mm in length)
- The modulus of rupture was measured on three sets of samples

Core Drilled Monolithic Zerodur	Modulus of Rupture (MPa)	Weibull Modulus
As received	59.3 +/- 5.5	11.2
Dip coated in bonding solution	51.7 +/- 6.7	8.0
Acid etched	126.3 +/- 36.8	3.4

- Acid etching greatly increases the strength of monolithic Zerodur®, and it also increases the distribution of flaw sizes on the surface
- Dip coating in bonding solution does not have the desired effect of “flaw healing” on the surface of the rods

Total change in length (TCL) of Zerodur® rods

- 20 disks of Zerodur® were bonded together to form a rod
- Rod contained a maximum of ~0.02 vol% of bonding material after curing
- Rods are 100 mm in length, 5mm in diameter



- TCL (-60 – 100°C)

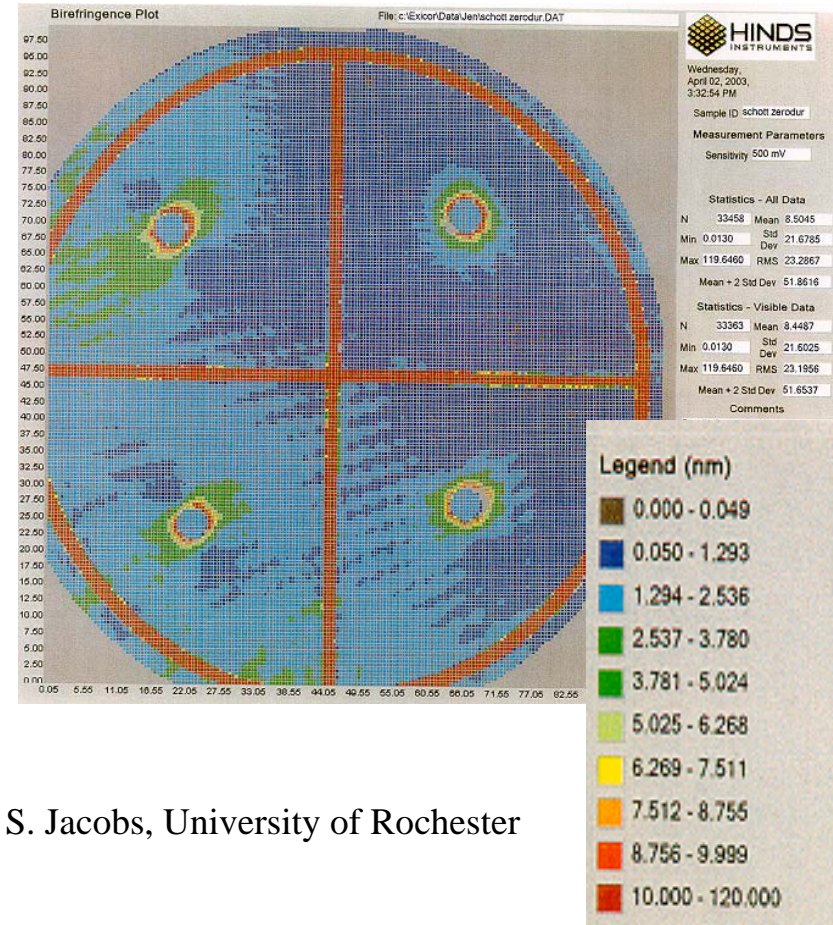
- Monolithic – 5.7 ppm
- Bonded – 6.8 ppm

Bonded components are vacuum stable

- A bonded Zerodur® valve has tested to 10^{-12} mbar/liter/sec (ultra-high vacuum range)
 - Leak rate below current detection limit (Calibrated helium leak, 2.6×10^{-8} std. cc/sec); lower than that typically specified by manufacturers of UHV valves
- Bonded Zerodur® light-weight mirror assemblies have survived aggressive coating chambers (CVD) (high temperature and pressure fluctuations)
 - Both fine ground cores and polished cores survived this coating procedure with no significant change in surface figure after coating

Bonded Zerodur® components have low stress birefringence

- Stress birefringence was measured on bonded pieces that had water jet cut cores
 - The maximum retardance was 40 nm/cm without acid etching
 - This is an unacceptable level due to the amount of residual stress it indicates
 - The maximum retardance was reduced to 8 nm/cm with acid etching
 - ✓ This is an acceptable level within specification for fine annealed optical glass



S. Jacobs, University of Rochester

Summary and future work



Summary of SCHOTT LTB

- A flexible low temperature bonding solution
- Can be used to build complex structures
- Can be polished and coated after bonding
- Thin bond lines for low distortion
- Near monolithic strength for bonded components

Future work

- Measure the thermal expansion of bonded Zerodur® components in a very controlled and precise system, as to measure the CTE of the joint material
- Determine the shrinkage characteristics of LTB bonds
- Determine post processing steps necessary to obtain surface figure stability of $\lambda/50$